

MOS FIELD EFFECT TRANSISTOR **2SJ607**

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

The 2SJ607 is P-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance: $R_{DS(on)1} = 11 \text{ m}\Omega \text{ MAX.}$ (VGs = -10 V, ID = -42 A) $R_{DS(on)2} = 16 \text{ m}\Omega \text{ MAX.}$ (VGs = -4.0 V, ID = -42 A)
- Low input capacitance: $C_{iss} = 7500 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V})$
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	Vdss	-60	V
Gate to Source Voltage (Vbs = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	∓83	А
Drain Current (pulse) ^{Note1}	D(pulse)	∓332	А
Total Power Dissipation (Tc = 25°C)	Р⊤	160	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	Р⊤	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	AS	-50	А
Single Avalanche Energy ^{Note2}	Eas	250	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ607	TO-220AB
2SJ607-S	TO-262
2SJ607-ZJ	TO-263
2SJ607-Z	TO-220SMD Note

Note TO-220SMD package is produced only in Japan



(TO-262)



(TO-263, TO-220SMD)



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Document No. Date Published Printed in Japan

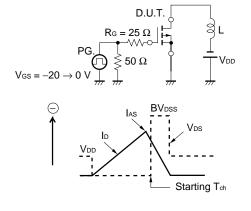
(TO-220AB)

ELECTRICAL CHARACTERISTICS (TA = 25°C)

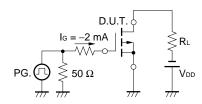
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = -60 V, Vgs = 0 V			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓10	μA
Gate Cut-off Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ Id} = -1 \text{ mA}$	-1.5	-2.0	-2.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = -10 \text{ V}, \text{ Id} = -42 \text{ A}$	45	90		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ Id} = -42 \text{ A}$		9.1	11	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -42 \text{ A}$		11	16	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		7500		pF
Output Capacitance	Coss	V _{GS} = 0 V		1800		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		430		pF
Turn-on Delay Time	td(on)	$V_{DD} = -30 \text{ V}, \text{ Id} = -42 \text{ A}$		23		ns
Rise Time	tr	V _{GS} = -10 V		16		ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		340		ns
Fall Time	tr			160		ns
Total Gate Charge	QG	Vdd= -48 V		188		nC
Gate to Source Charge	Q _{GS}	V _{GS} = -10 V		30		nC
Gate to Drain Charge	Qgd	I⊳ = −83 A		48		nC
Body Diode Forward Voltage	VF(S-D)	IF = 83 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 83 A, VGS = 0 V		64		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		150		nC

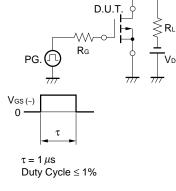
TEST CIRCUIT 1 AVALANCHE CAPABILITY

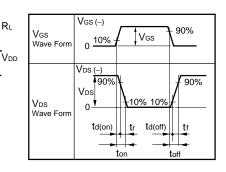
TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE







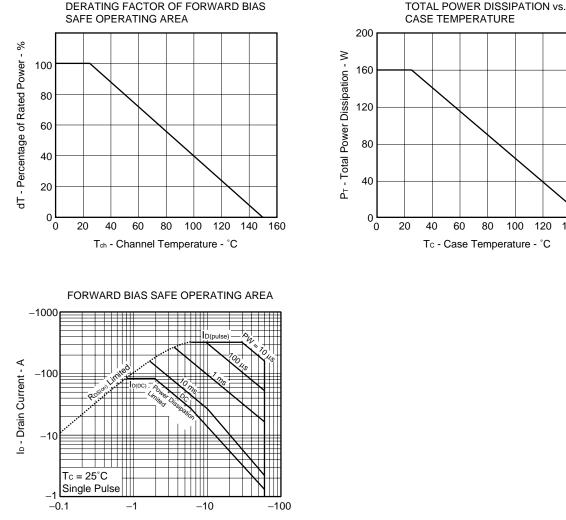
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100

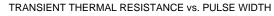
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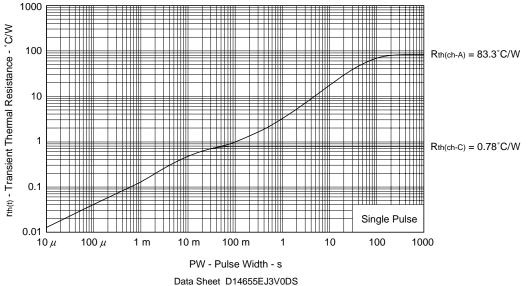
140

TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

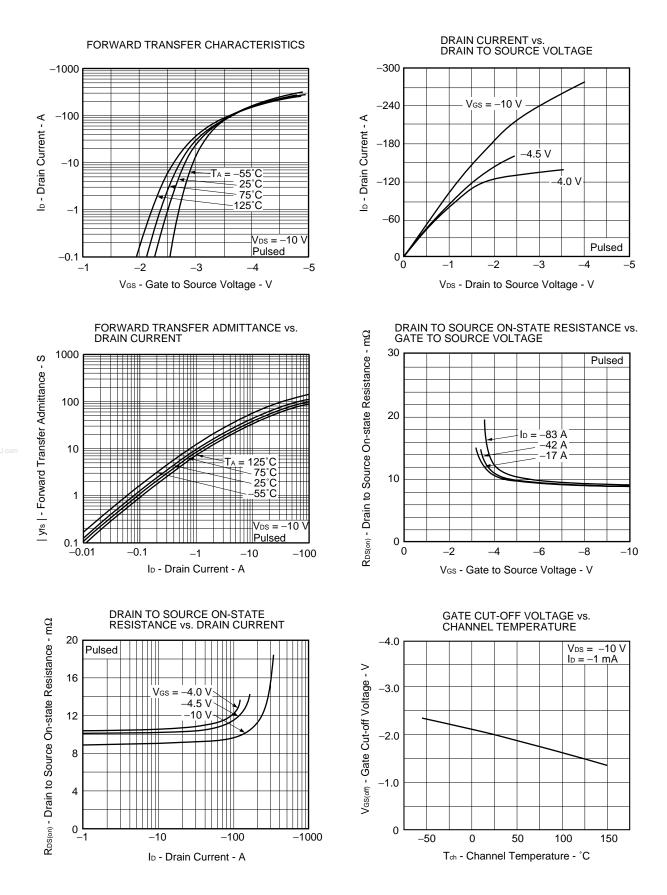


VDS - Drain to Source Voltage - V

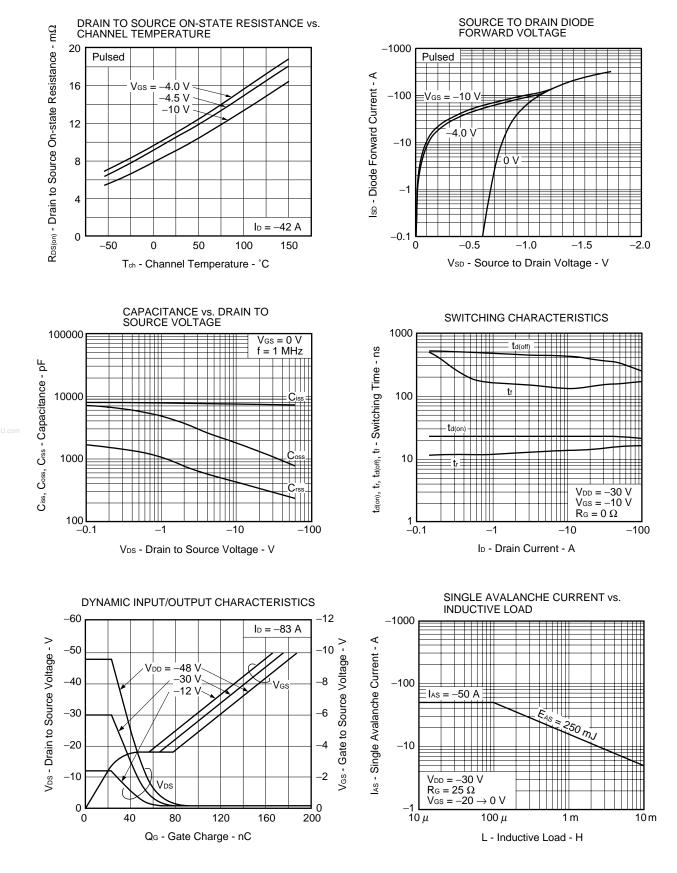




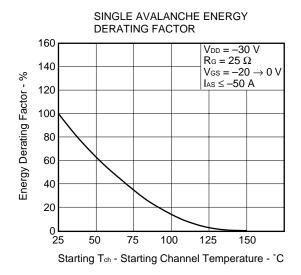
3 www.DataSheet4U.com



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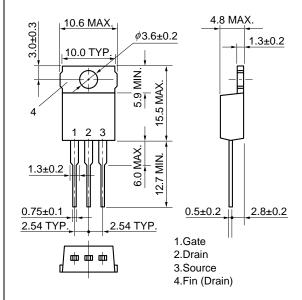


Data Sheet D14655EJ3V0DS

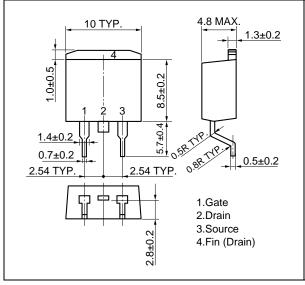


* PACKAGE DRAWINGS (Unit: mm)

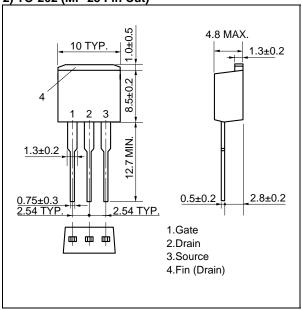
1) TO-220AB (MP-25)



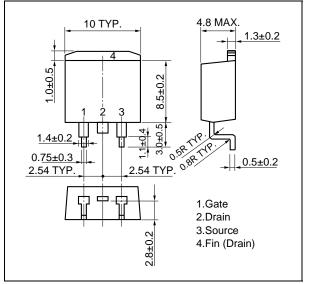
3) TO-263 (MP-25ZJ)



2) TO-262 (MP-25 Fin Cut)

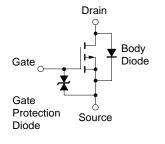


4) TO-220SMD (MP-25Z) Note



Note This package is produced only in Japan.

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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